

## PATENT

## ASSIGNMENT

WHEREAS, I/WE (1) Hideo HADA,  
a Japanese citizen, residing at Kawasaki-shi, Japan

(2) Masaru TAKESHITA,  
a Japanese citizen, residing at Kawasaki-shi, Japan

(3) Ryotaro HAYASHI,  
a Japanese citizen, residing at Kawasaki-shi, Japan

(4) Syogo MATSUMARU,  
a Japanese citizen, residing at Kawasaki-shi, Japan

(5) Taku HIRAYAMA,  
a Japanese citizen, residing at Kawasaki-shi, Japan

(6) Hiroaki SHIMIZU,  
a Japanese citizen, residing at Kawasaki-shi, Japan

hereinafter referred to as Assignor (collectively if more than one inventor is listed above), have invented certain new and useful improvements in

RESIST COMPOSITION AND METHOD FOR FORMING RESIST PATTERN

the specification of which:

- (a) ☐ was executed on even date herewith;
- (b) ☐ was filed on \_\_\_\_\_ as Application No. 0 / \_\_\_\_\_ or o Express Mail No., as Application No. not yet known \_\_\_\_\_ and was amended on \_\_\_\_\_ (if applicable); or
- (c) ☒ was described and claimed in PCT International Application No. PCT/JP2004/015504 filed on October 20, 2004 and as amended under PCT Article 19 on \_\_\_\_\_ (if any) and/or under PCT Article 34 on \_\_\_\_\_ (if any).

AND WHEREAS, TOKYO OHKA KOGYO CO., LTD., with its principal place of business at 150, Nakamaruko, Nakahara-ku, Kawasaki-shi, Kanagawa-ken, Japan, (hereinafter referred to as Assignee) desires to acquire the entire right, title, and interest in and to the said improvements with respect to the United States of America, its territories and possessions.

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, Assignor hereby acknowledges that it has sold, assigned, transferred and set over, and by these presents does hereby sell, assign, transfer and set over, unto Assignee, its successors, legal representatives and assigns, the entire right, title, and interest in the United States of America, and its territories and possessions in, to and under said improvements, and any Patent Applications in the United States of America and all divisions, renewals and continuations thereof, and all Patents of the United States of America which may be granted thereon and all reissues and extensions thereof, and all rights of priority under International Conventions; and Assignor hereby authorizes and requests the Commissioner of Patents of the United States of America to issue all Patents for said improvements to Assignee, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND ASSIGNOR HEREBY covenants and agrees that it will communicate to Assignee, its successors, legal representatives and assigns, any facts known to it respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in the United States of America.

IN TESTIMONY WHEREOF, Assignor intending to be legally bound has hereunto affixed its signature.

This 1st day of April, 2007

Hideo Hada  
Signature of Hideo HADA

This 1st day of April, 2007

Masaru Takeshita  
Signature of Masaru TAKESHITA

This 1st day of April, 2007

Ryotaro Hayashi  
Signature of Ryotaro HAYASHI

This 1st day of April, 2007

Syogo Matsumaru  
Signature of Syogo MATSUMARU

This 1st day of April, 2007

Taku Hirayama  
Signature of Taku HIRAYAMA

This 1st day of April, 2007

Hiroaki Shimizu  
Signature of Hiroaki SHIMIZU

Witnessed by:

Chieko Sugimoto